

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Hiroyuki Sakamoto et al.

Application No.: 10/528,153

Confirmation No.: 2814

Filed: August 19, 2005

Art Unit: 1795

For: METHOD OF ADHESION OF CONDUCTIVE
MATERIALS, LAMINATE, AND ADHESIVE
COMPOSITION

Examiner: TAI, Xiuyu

RESPONSE TO NON-FINAL OFFICE ACTION UNDER 37 CFR 1.111

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

This is in response to the Office Action dated August 5, 2008.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.